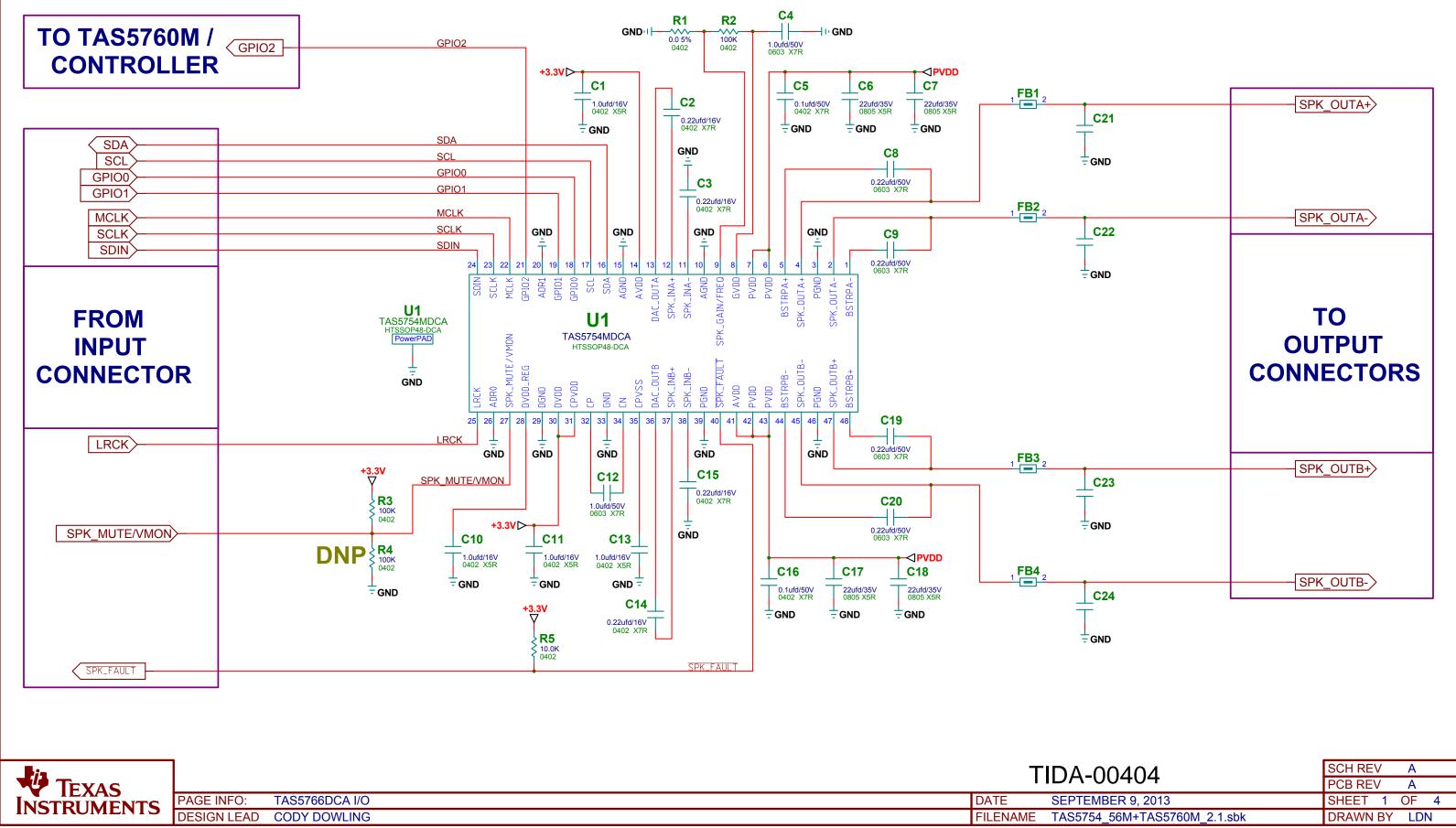
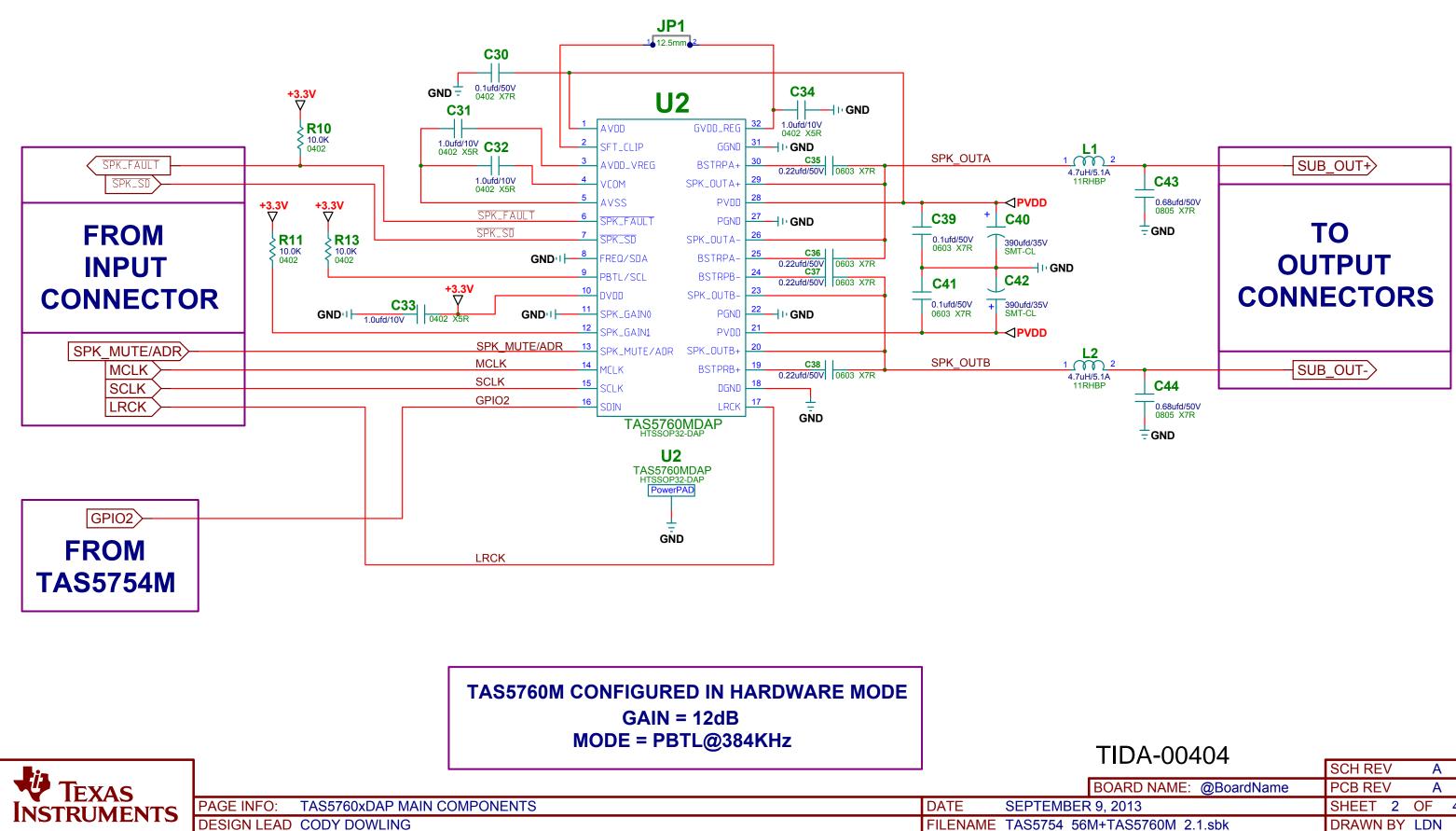
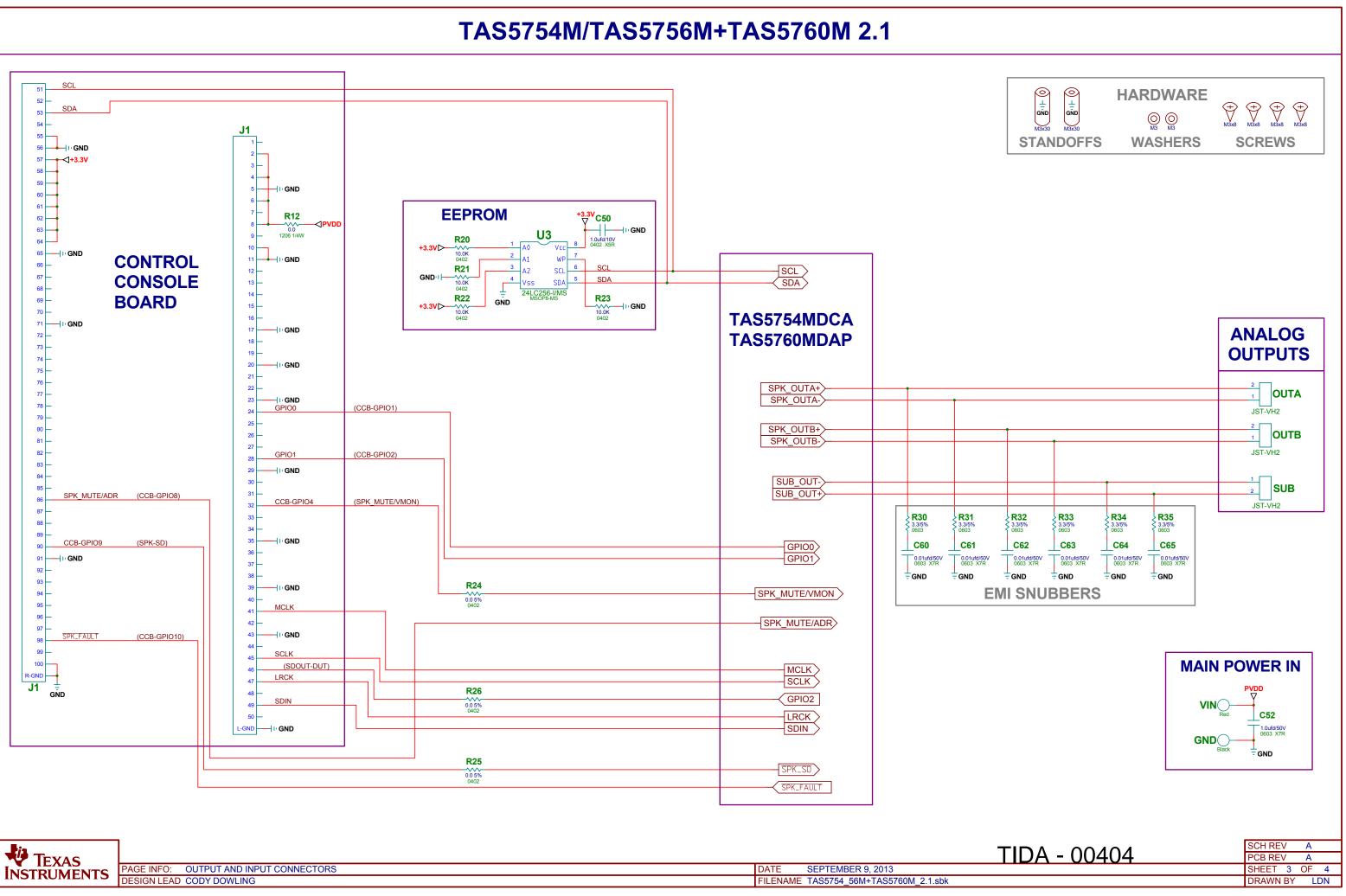
## TAS5754M/TAS5756M+TAS5760M 2.1



# **TAS5754M/TAS5756M+TAS5760M 2.1**



	SCH REV A
BOARD NAME: @BoardName	PCB REV A
9, 2013	SHEET 2 OF 4
//+TAS5760M_2.1.sbk	DRAWN BY LDN





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